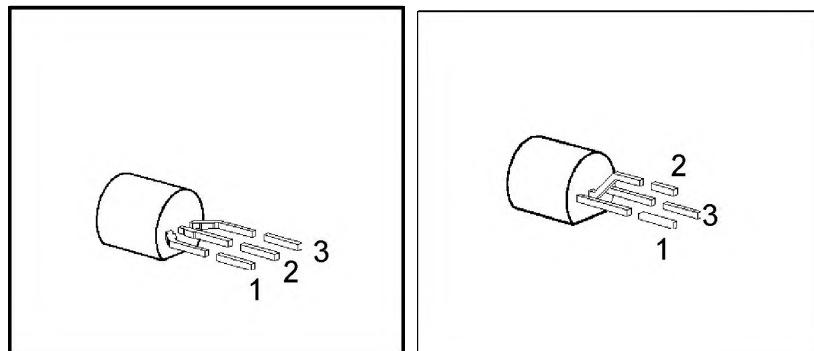


- V_{DS} 100 V
- I_D 0.22 A
- $R_{DS(on)}$ 6.0 Ω
- $V_{GS(th)}$ 0.8 ... 2.0 V
- N channel
- Enhancement mode
- Logic level



Type	Ordering Code	Tape and Reel Information	Pin Configuration			Marking	Package
			1	2	3		
BSS 100	Q62702-S483	bulk	S	G	D	BSS 100 marked SS100	TO-92
BSS 100	Q62702-S499	E6288: 1500 pcs/reel; 2 reels/carton; gate first					
BSS 100	Q62702-S007	E6296: 1500 pcs/reel; 2 reels/carton; source first					
BSS 100	Q67000-S206	E6325: 2000 pcs/carton; Ammopack					

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	V_{DS}	100	V
Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$	V_{DGR}	100	
Gate-source voltage	V_{GS}	± 14	
Gate-source peak voltage, aperiodic	V_{gs}	± 20	
Continuous drain current, $T_A = 33^\circ\text{C}$	I_D	0.22	A
Pulsed drain current, $T_A = 25^\circ\text{C}$	$I_{D \text{ puls}}$	0.9	
Max. power dissipation, $T_A = 25^\circ\text{C}$	P_{tot}	0.63	W
Operating and storage temperature range	T_j, T_{stg}	$-55 \dots +150$	°C

Thermal resistance, chip-ambient (without heat sink)	R_{thJA}	≤ 200	K/W
DIN humidity category, DIN 40 040	–	E	–
IEC climatic category, DIN IEC 68-1	–	55/150/56	

Electrical Characteristicsat $T_j = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain-source breakdown voltage $V_{GS} = 0$, $I_D = 0.25 \text{ mA}$	$V_{(BR)DSS}$	100	—	—	V
Gate threshold voltage $V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	$V_{GS(\text{th})}$	0.8	1.5	2.0	
Zero gate voltage drain current $V_{DS} = 100 \text{ V}$, $V_{GS} = 0$ $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	I_{DSS}	—	0.1	1.0	μA
		—	2	60	
		—	—	10	nA
		—	—	10	
Gate-source leakage current $V_{GS} = 20 \text{ V}$, $V_{DS} = 0$	I_{GSS}	—	1	10	nA
Drain-source on-resistance $V_{GS} = 10 \text{ V}$, $I_D = 0.22 \text{ A}$ $V_{GS} = 4.5 \text{ V}$, $I_D = 0.22 \text{ A}$	$R_{DS(\text{on})}$	—	3.5	6.0	Ω
		—	5.0	10.0	

Dynamic Characteristics

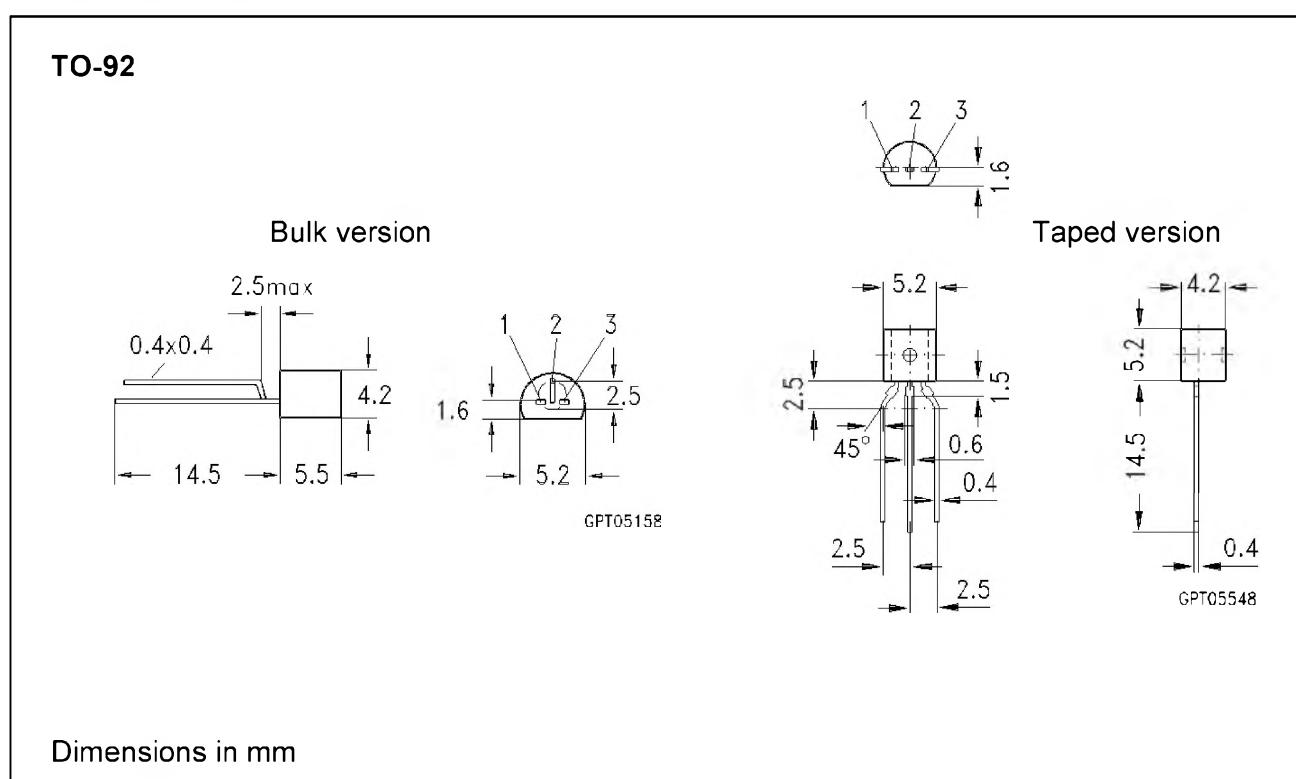
Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(\text{on})\text{max}}$, $I_D = 0.22 \text{ A}$	g_{fs}	0.08	0.22	—	S
Input capacitance $V_{GS} = 0$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	—	65	85	pF
Output capacitance $V_{GS} = 0$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	—	10	15	
Reverse transfer capacitance $V_{GS} = 0$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	—	4	6	
Turn-on time t_{on} , ($t_{\text{on}} = t_{d(\text{on})} + t_r$) $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $R_{GS} = 50 \Omega$, $I_D = 0.28 \text{ A}$	$t_{d(\text{on})}$	—	5	8	ns
	t_r	—	5	8	
Turn-off time t_{off} , ($t_{\text{off}} = t_{d(\text{off})} + t_f$) $V_{DD} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $R_{GS} = 50 \Omega$, $I_D = 0.28 \text{ A}$	$t_{d(\text{off})}$	—	10	13	
	t_f	—	12	16	

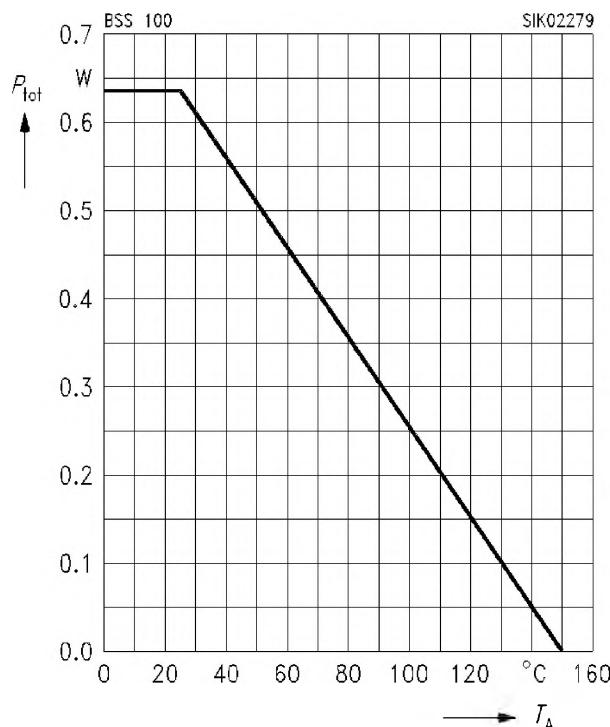
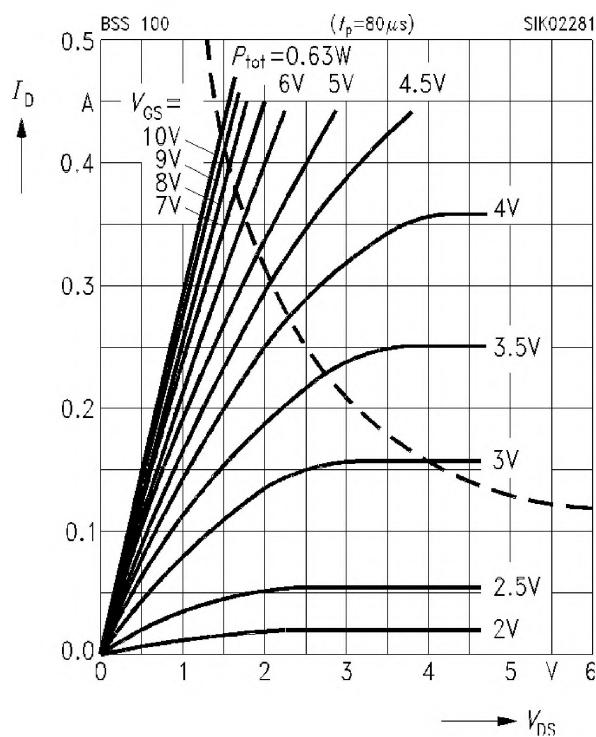
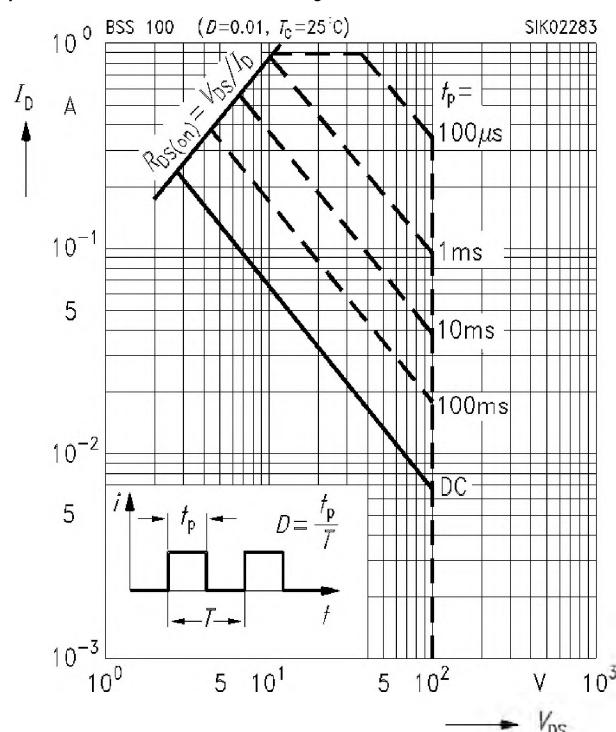
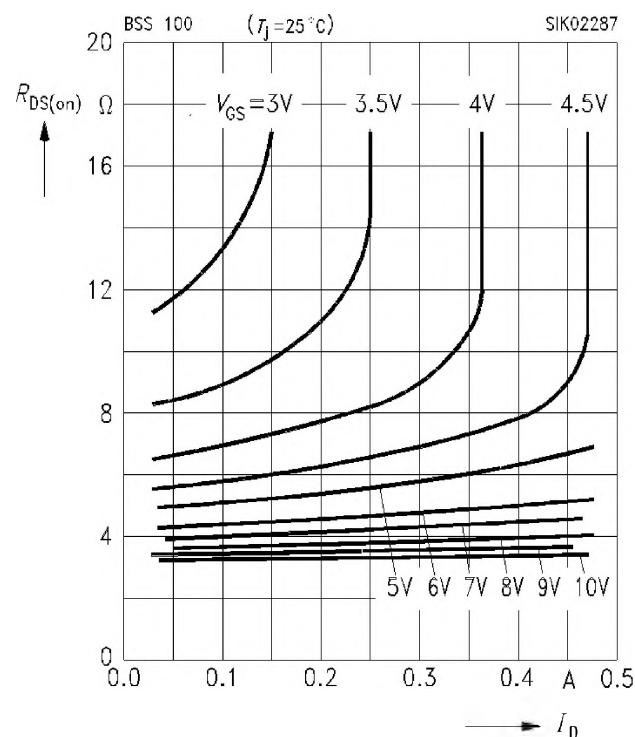
Electrical Characteristics (cont'd)at $T_j = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

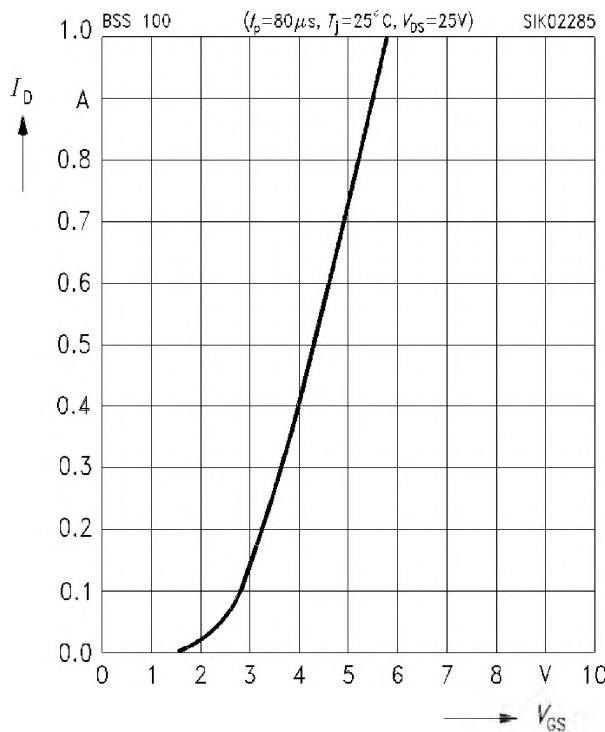
Reverse Diode

Continuous reverse drain current $T_A = 25^\circ\text{C}$	I_S	—	—	0.22	A
Pulsed reverse drain current $T_A = 25^\circ\text{C}$	I_{SM}	—	—	0.90	
Diode forward on-voltage $I_F = 0.44 \text{ A}, V_{GS} = 0$	V_{SD}	—	0.9	1.3	V

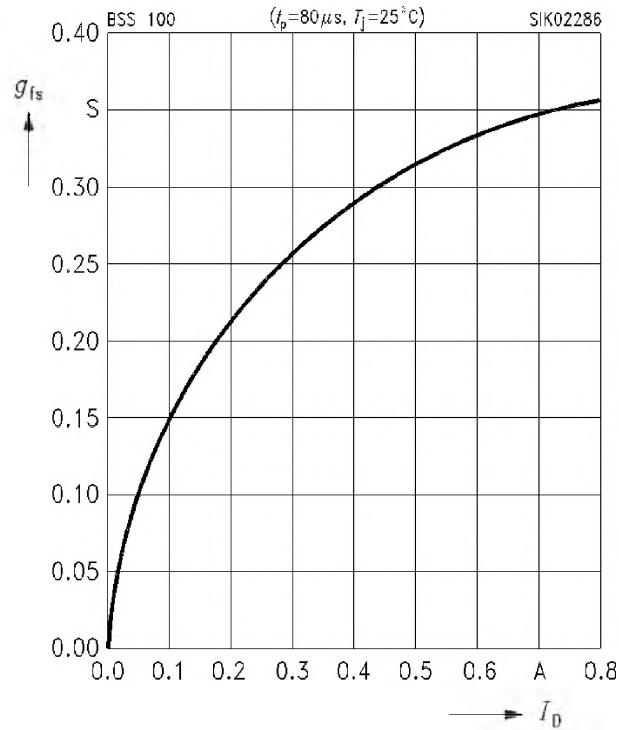
Package Outline

Characteristicsat $T_j = 25^\circ\text{C}$, unless otherwise specified.**Total power dissipation** $P_{\text{tot}} = f(T_A)$ **Typ. output characteristics** $I_D = f(V_{DS})$
parameter: $t_p = 80 \mu\text{s}$ **Safe operating area** $I_D = f(V_{DS})$ parameter: $D = 0.01, T_C = 25^\circ\text{C}$ **Typ. drain-source on-resistance** $R_{DS(on)} = f(I_D)$ parameter: V_{GS} 

Typ. transfer characteristics $I_D = f(V_{GS})$
 parameter: $t_p = 80 \mu\text{s}$, $V_{DS} \geq 2 \times I_D \times R_{DS(\text{on})\text{max.}}$

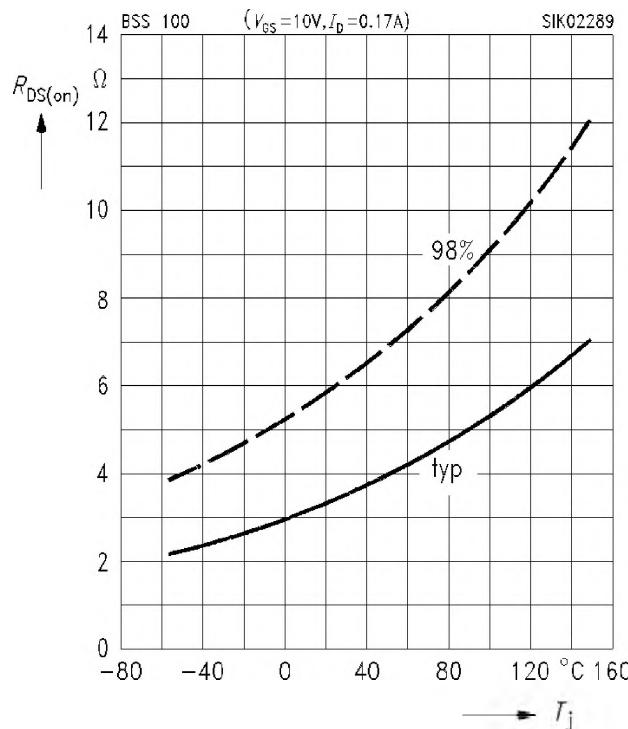


Typ. forward transconductance $g_{fs} = f(I_D)$
 parameter: $V_{DS} \geq 2 \times I_D \times R_{DS(\text{on})\text{max.}}, t_p = 80 \mu\text{s}$

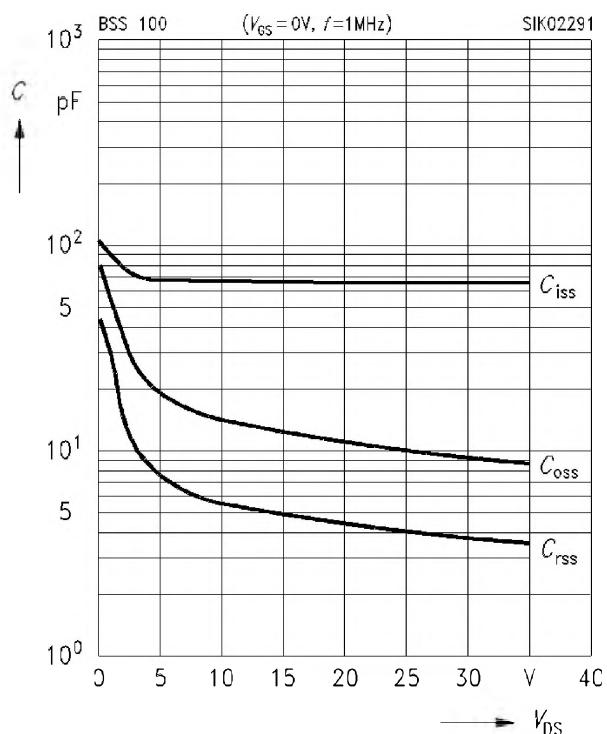


Drain-source on-resistance

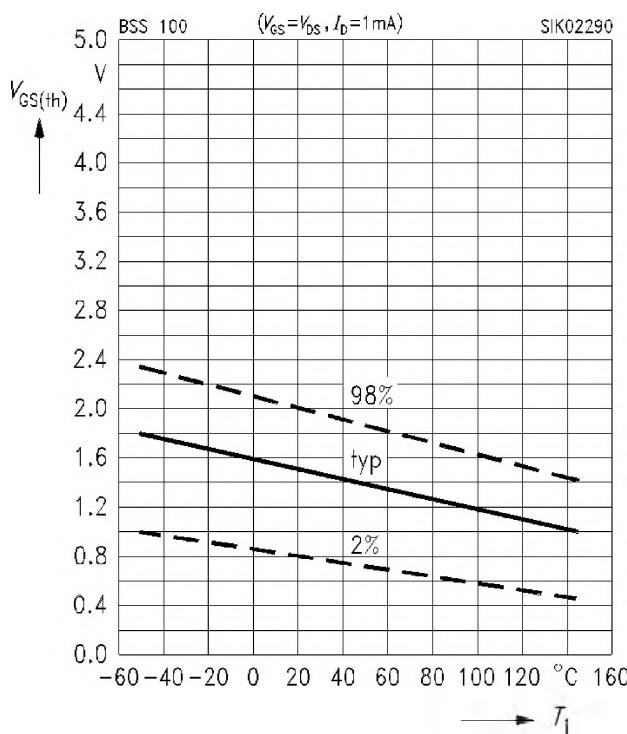
$R_{DS(\text{on})} = f(T_j)$
 parameter: $I_D = 0.22 \text{ A}, V_{GS} = 10 \text{ V}$, (spread)



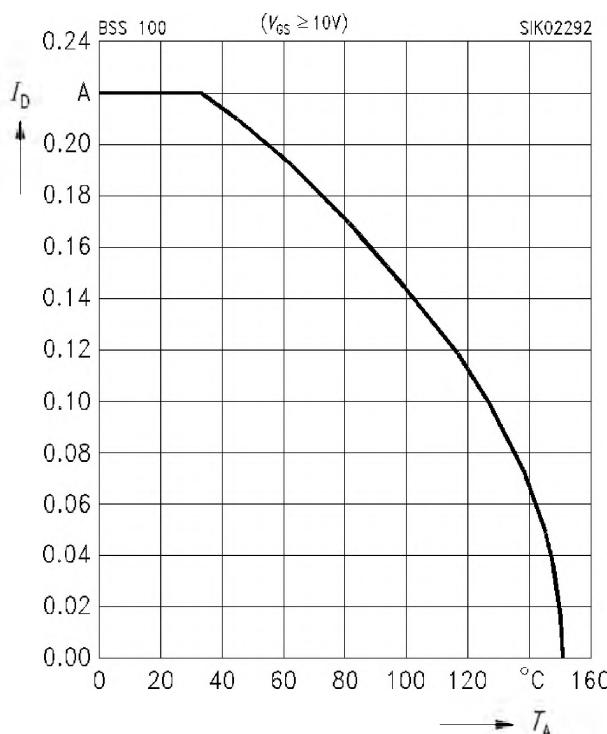
Typ. capacitances $C = f(V_{DS})$
 parameter: $V_{GS} = 0, f = 1 \text{ MHz}$



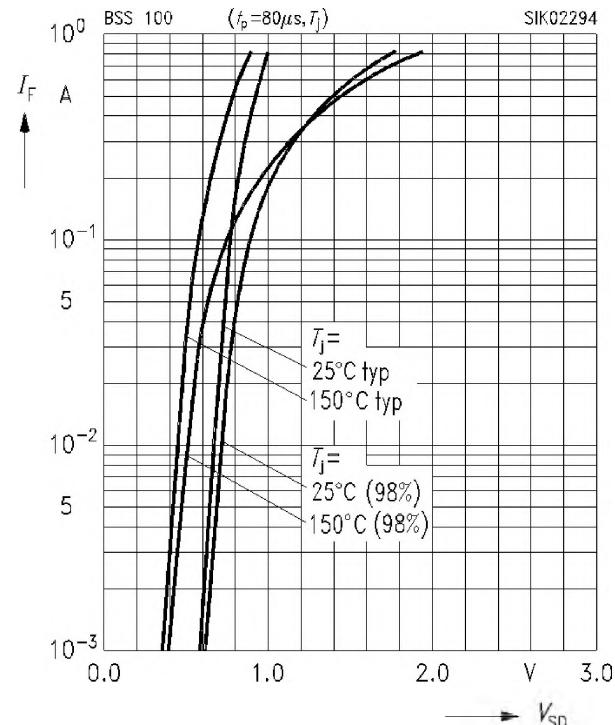
Gate threshold voltage $V_{GS(th)} = f(T_j)$
 parameter: $V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$, (spread)



Drain current $I_D = f(T_A)$
 parameter: $V_{GS} \geq 5 \text{ V}$



Forward characteristics of reverse diode
 $I_F = f(V_{SD})$
 parameter: $t_p = 80 \mu\text{s}$, T_j , (spread)



Drain-source breakdown voltage
 $V_{(BR)DSS} = b \times V_{(BR)DSS} (25^\circ\text{C})$

